

Excellent Integrated System Limited

Stocking Distributor

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ON Semiconductor NRVBS2040LT3G

For any questions, you can email us directly: sales@integrated-circuit.com



MBRS2040LT3G, NRVBS2040LT3G

Surface Mount Schottky Power Rectifier

SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

Features

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- ESD Ratings:
 - ♦ Human Body Model = 3B (> 16000 V)
 - ◆ Machine Model = C (> 400 V)
- AEC-Q101 Qualified and PPAP Capable
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free*

Mechanical Characteristics

- · Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Maximum Temperature of 260°C / 10 Seconds for Soldering
- Cathode Polarity Band
- Available in 12 mm Tape, 2500 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: BKJL



ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 40 VOLTS



SMB CASE 403A

MARKING DIAGRAM



BKJL = Specific Device Code A = Assembly Location

A = Assembly Location
Y = Year
WW = Work Week
= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRS2040LT3G	SMB (Pb-Free)	2,500 / Tape & Reel
NRVBS2040LT3G	SMB (Pb-Free)	2,500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Datasheet of NRVBS2040LT3G - DIODE SCHOTTKY 40V 2A SMB

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V	
Average Rectified Forward Current (At Rated V_R , $T_C = 103^{\circ}C$)	I _O	2.0	Α	
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 20 kHz, T _C = 104°C)	I _{FRM}	4.0	Α	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	70	Α	
Storage Temperature	T _{stg} , T _C	-55 to +150	°C	
Operating Junction Temperature	TJ	-55 to +125	°C	
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic		Value	Unit	
Thermal Resistance — Junction-to-Lead (Note 1) Thermal Resistance — Junction-to-Ambient (Note 2)	$R_{ hetaJL} \ R_{ hetaJA}$	22.5 78	°C/W	

^{1.} Minimum pad size (0.108 X 0.085 inch) for each lead on FR4 board.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value		Unit	
Maximum Instantaneous Forward Voltage (Note 3)	V _F	T _J = 25°C	T _J = 125°C	Volts	
see Figure 2 (I _F = 2.0 A) (I _F = 4.0 A)		0.43 0.50	0.34 0.45		
Maximum Instantaneous Reverse Current (Note 3) see Figure 4	I _R	T _J = 25°C	T _J = 100°C	mA	
(V _R = 40 V) (V _R = 20 V)		0.8 0.1	20 6.0		

^{3.} Pulse Test: Pulse Width \leq 250 μ s, Duty Cycle \leq 2.0%.

^{2. 1} inch square pad size (1 x 0.5 inch for each lead) on FR4 board.



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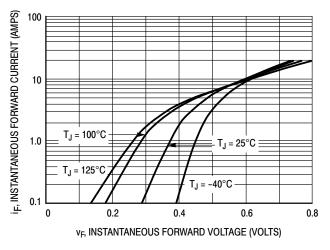


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

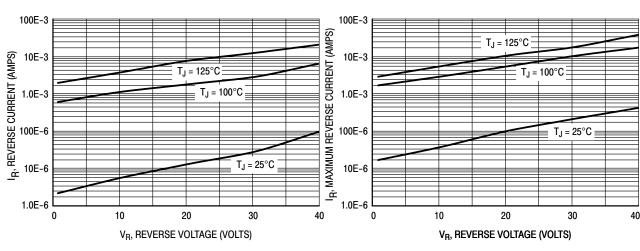
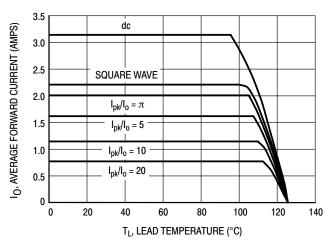


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current





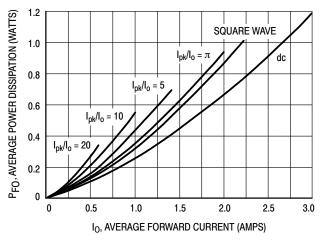


Figure 6. Forward Power Dissipation

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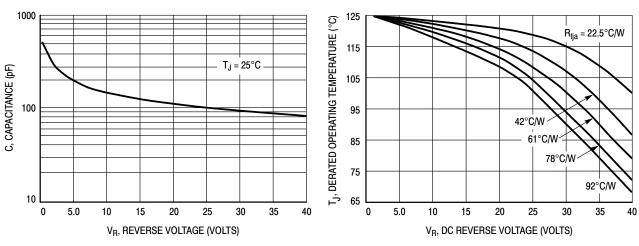


Figure 7. Capacitance

Figure 8. Typical Operating Temperature Derating*

* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T, therefore must include forward and reverse power effects. The allowable operating $T_J = T_{Jmax} - r(t)(Pf + Pr)$ where T_J may be calculated from the equation:

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable T_J due to reverse bias under DC conditions only and is calculated as $T_J = T_{Jmax} - r(t)Pr$, where r(t) = Rthja. For other power applications further calculations must be performed.

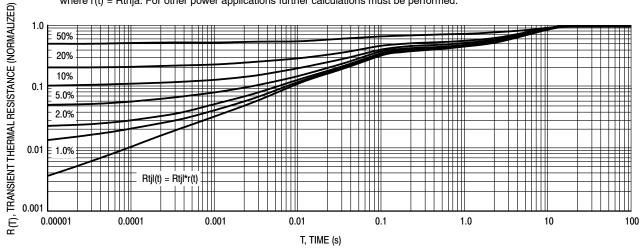


Figure 9. Thermal Response Junction to Lead

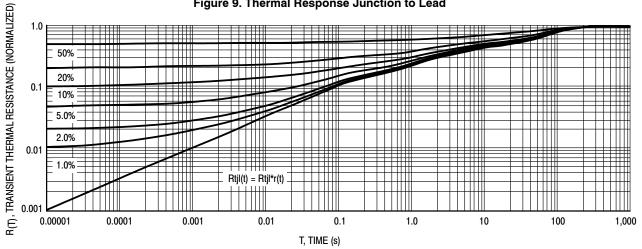


Figure 10. Thermal Response Junction to Ambient



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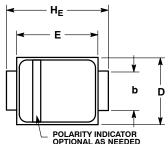
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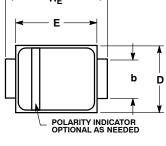
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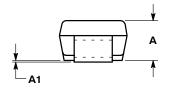
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PACKAGE DIMENSIONS

SMB CASE 403A-03 **ISSUE H**



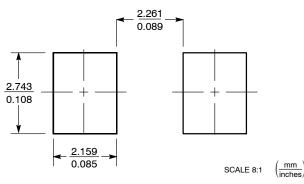




- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: INCH.
 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.90	2.20	2.28	0.075	0.087	0.090
A1	0.05	0.10	0.19	0.002	0.004	0.007
b	1.96	2.03	2.20	0.077	0.080	0.087
С	0.15	0.23	0.31	0.006	0.009	0.012
D	3.30	3.56	3.95	0.130	0.140	0.156
E	4.06	4.32	4.60	0.160	0.170	0.181
HE	5.21	5.44	5.60	0.205	0.214	0.220
L	0.76	1.02	1.60	0.030	0.040	0.063
L1	0.51 REF			0.020 REF		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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